

MESSRS.**SPECIFICATION FOR APPROVAL****承 認 书**

Product	ELECTRET CONDENSER MICROPHONE
Part No.	HMB-O40J42-CWH28(RoHS)
Customer Part No.	
Customer Approval	

Approved By	Checked By	Made By
王台平 MAY-13-2016	曹丽萍 MAY-13-2016	LILY MAY-13-2016

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EDITION:1.1

2. 储藏与判断条件 (Storage And Judgement Conditions)

	Temperature Range(°C)	Rel. Humidity(%)	Static Pressure(kPa)
Judgement	19~21	60~70	86~106
Storage	-25~70		
Operating	-25~70		

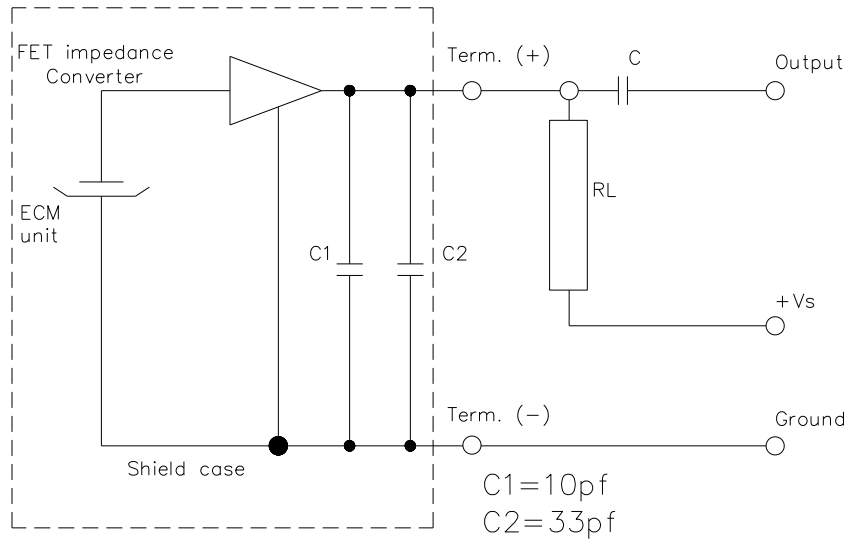
3. 规格 (Specifications)

Test conditions($V_S=2.0V$ $R_L=2.2k\Omega$ $Temp=20\pm 2^{\circ}C$ $R.H=60\pm 5\%$)

Item	Symbol	Test Conditions	Min	Standard	Max	Unit
灵敏度 Sensitivity	S	$f=1kHz, Pin=1Pa$	-45	-42	-39	dB (0dB=1V/Pa)
阻抗 Impedance	Z	$f=1kHz, Pin=1Pa$			2.2	k Ω
指向性 Directivity	Omni-directional					
消耗电流 Current Consumption	I				500	μA
工作电压 Operation Voltage Range	U		1.0	2.0	10	V
信噪比 S/N Ratio	S/N(A)	$f=1kHz, Pin=1Pa$ A Curve	58			dB
降压特性 Decreasing Voltage Characteristic	ΔS	$f=1kHz, Pin=1Pa$ $V_S=2.0-1.5V$			-3	dB
最大输入声压级 Max.Input Sound Level	MISPL	$f=1kHz$ Distortion<1%			110	dB

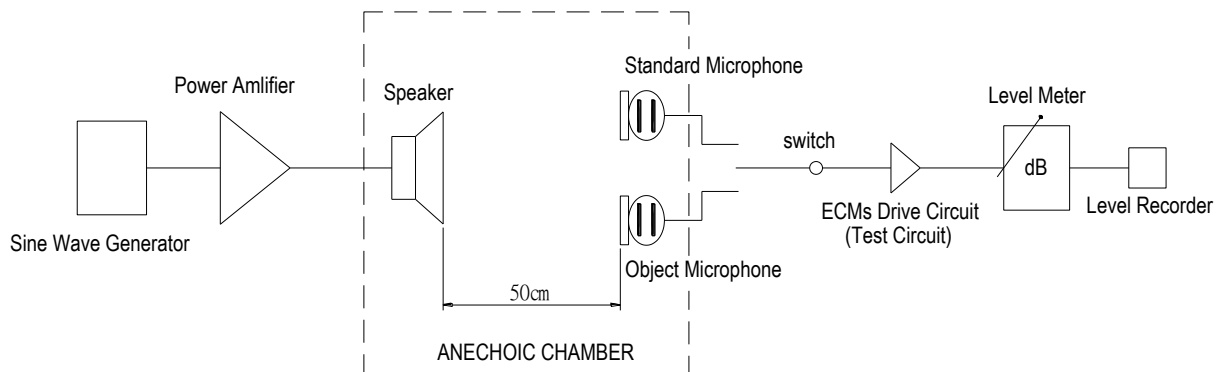
4. 测试电路 (Standard Test Circuit)

$V_s=2.0V$ $R_L=2.2k\Omega$ $T_e=20^\circ C$ $R.H.=60\%$

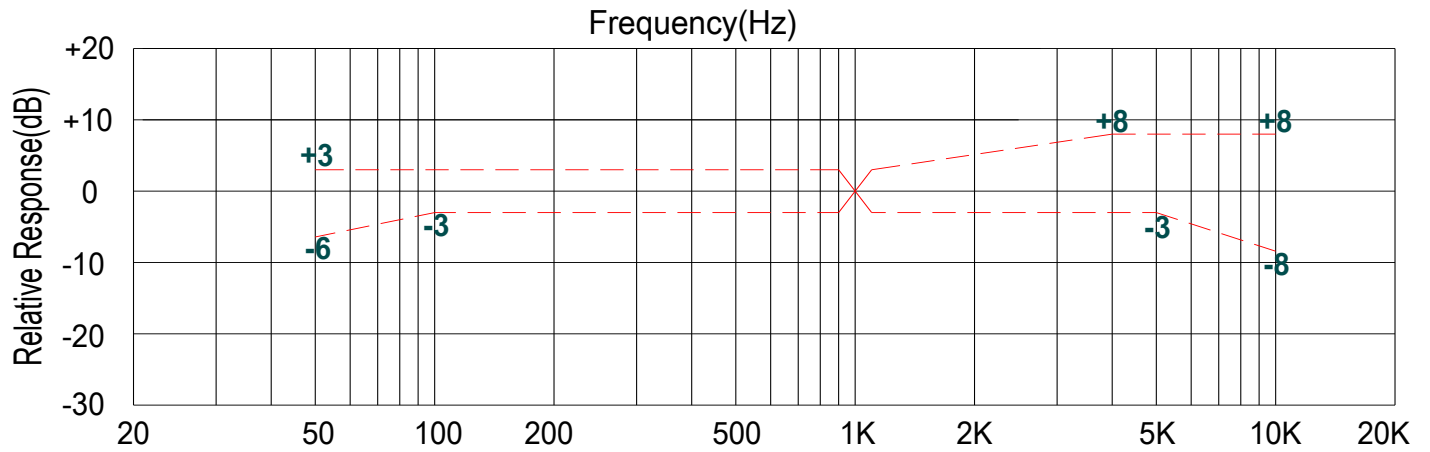


5. 测试装备图 (Standard Test Fixture)

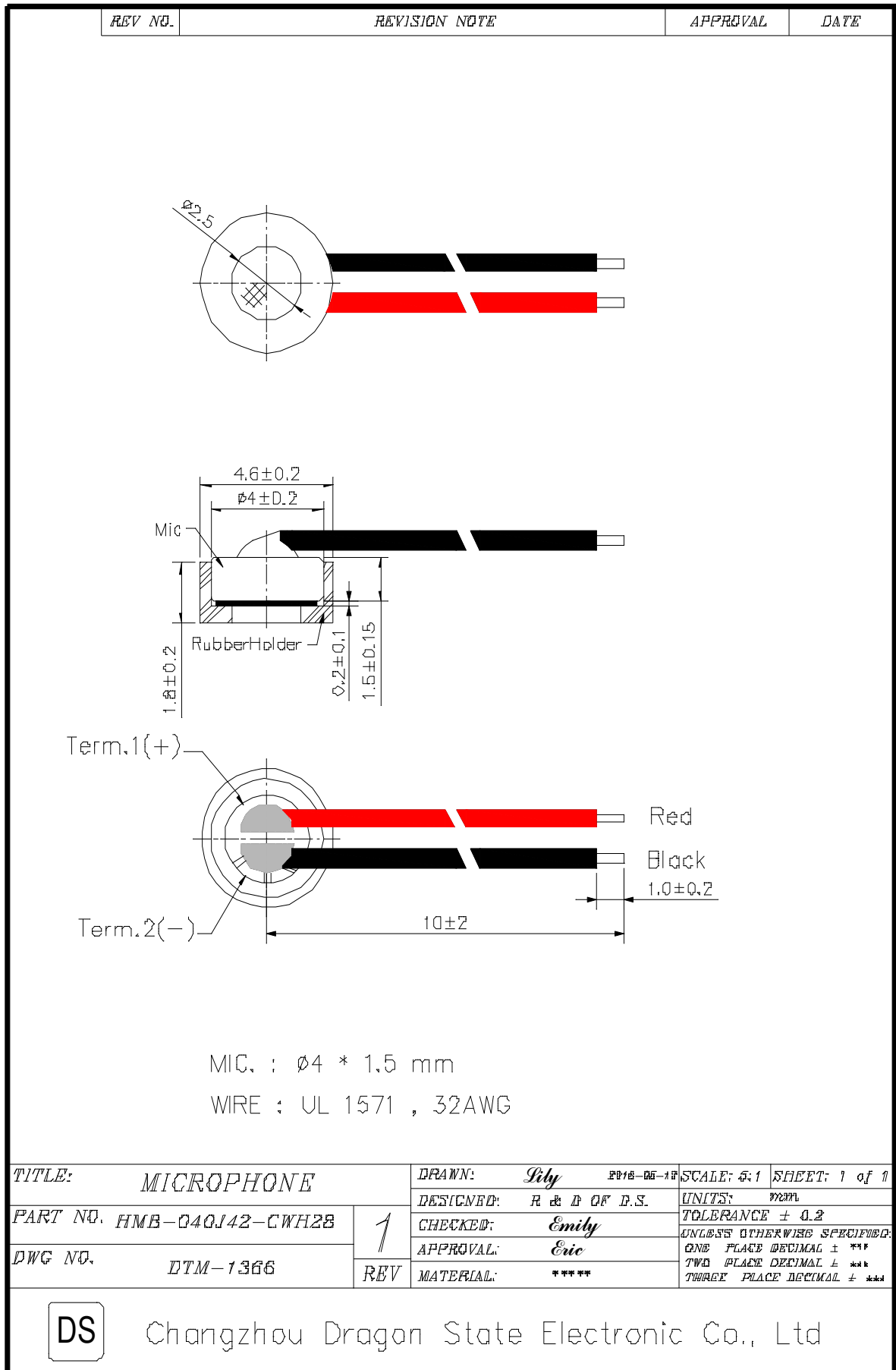
MEASUREMENT OF SENSITIVITY

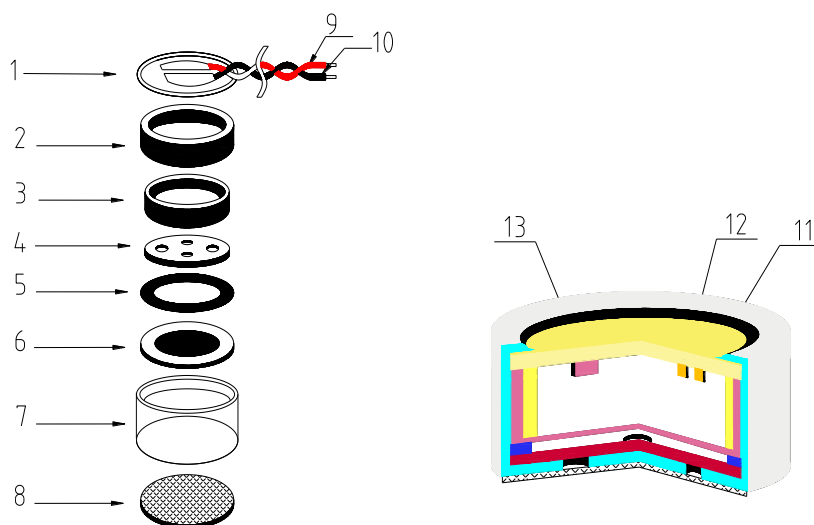


6 频响曲线 (Frequency Response Curve)



7,外观图 (Appearance Drawing) 8. 材料及结构清单 (List and Structure of Materials)





No. 序号	Part name 部件名称	Material Type 材料型号	Qty 数量	Origin 产地	Manufacture 协力厂商	Remarks 备注
1	PCB	Epoxy FR-4	1	Hongkong	Jiantao	
2	Cavity	POM	1	Japan	Suzhou	
3	Copper ring	Brass AT65	1	China	Suzhou	
4	Back plate	ALSET FC-CNZ	1	Korea	3A	
5	Cushion plate	Mylar	1	China	Hebei	
6	Diaphragm	PPS	1	Japan	Dongli	
7	Case	Magal	1	China	Shanghai	
8	Cloth	non-woven fabrics	1	Japan	Sanjing	
9	Lead wire	UL1571 AWG 32	1	China	Shanghai	Red+
10	Lead wire	UL1571 AWG 32	1	China	Shanghai	Black-
11	Capacitor	10pF 0402	1	Japan	Murata	
12	Capacitor	33pF 0402	1	Japan	Murata	
13	FET	TF252THC	1	Japan	Sanyo	

9.可靠性试验 (Reliability Test)

在下列试验完成后,在温度为 20°C,相对湿度为 65%的条件下恢复 3 小时后进行测试,灵敏度与初始灵敏度相差在 $\pm 3\text{dB}$ 以内.

(All tests should be done after 3 hours of conditioning at 20°C, R.H65%, while the sensitivity is to be within $\pm 3\text{dB}$, from the initial sensitivity after the following experiments.)

9.1 高温试验 (HIGH TEMPERATURE TEST)

温度(High temperature): +70°C

放置时间(Duration): 240hours

9.2 低温试验 (LOW TEMPERATURE TEST)

温度(Low temperature): -30°C

放置时间(Duration): 240 hours

9.3 温度循环试验(如图 1) (TEMPERATURE CYCLE TEST)(See in Fig.1)

低温(Low temperature): -30°C

高温(High temperature): +70°C

转化时间(Changeover time): 10min

放置时间(Duration): 30min

次数(Cycle): 5

9.4 湿度 (STATICAL HUMIDITY TEST)

温度(Temperature): +50°C

相对湿度(Relative humidity): 90 ~ 95%

放置时间(Duration): 200 hours

9.5 振动试验 (VIBRATION TEST)

振幅(Amplitude): 1.52mm

持续时间(Duration): 1 分钟/面(minutes/plane)

频度范围(Freq.range): 10 ~ 55Hz

试验时间(Total time): 2 小时(hour)

9.6 跌落试验 (DROP TEST)

不带包装的跌落到 20mm 厚的地板上(Drop a unit unpacked onto a board of 20mm thick)

高度(Height): 1 m

次数(Cycle): 6 (1 each plane)

9.7 静电测试 (ESD TEST)

在两次无杂质的静电释放暴露中放电.(接触:±8Kv,空气:±15 Kv)麦克风在 10 次暴露后无干扰

The microphone under test must be discharged between each ESD exposure without ground.

(contact:±8 kV, air:±15 kV)There is no interference in operation after 10 times exposure.

10. 焊接要求 (Regarding the Soldering operation)

每个驻极体电容传声器在其麦克风上都有一个 FET,这种 FET 在过热和电流撞击时易损坏，所以对于焊接应遵

循以下操作：

- 要求使用 25W-35W 烙铁，并保持 $350\pm 10^{\circ}\text{C}$ 的温度范围。
- 在每一个端的焊接应在 2 秒内完成，以防过热。
- 禁止单体麦克风焊接。（否则会影响驻极体电容传声器的灵敏度）
- 最理想的散热装置按以下设计。

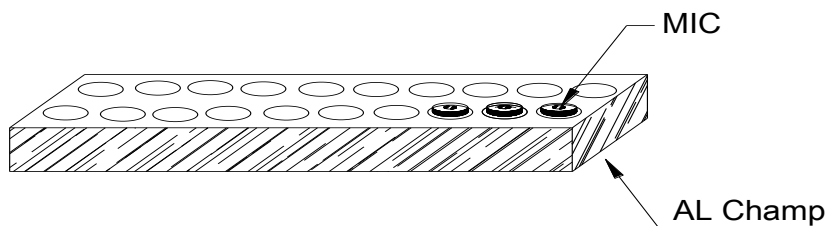
Every ECM contains a FET with microphone body.

This FET easy to damageable from excessive heat and electrical shock. Proper attention for the soldering work is required same as followings.

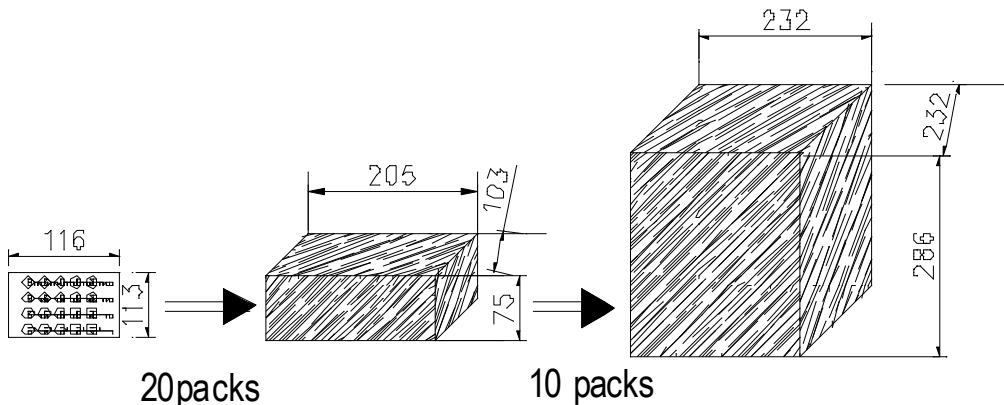
- Recommend to use 25W-35W ceramic soldering iron and apply $350\pm 10^{\circ}\text{C}$ temperature range
- Soldering should be accomplished within 2 seconds at each terminal so as not to be overheated.
- Do not make a cavity at the surface of lead lump on the PCB. wiring board.

(Opened cavity will influence to the sensitivity of ECM)

- Optimal design for heat sink pad is same as below.



11. 包装规格 (Packing Specifications)

REV NO.	REVISION NOTE	APPROVAL	DATE			
						
<table style="width: 100%; border: none;"> <tr> <td style="width: 33%; vertical-align: top;"> 100pcs per plastic bag N/W:15g G/W:20g MODEL: QTY:50PCS LOT NO: </td> <td style="width: 33%; vertical-align: top;"> 1000pcs per plastic box N/W:300g G/W:450g MODEL: QTY:1000PCS LOT NO: </td> <td style="width: 33%; vertical-align: top;"> 10000pcs per out bag N/W:3.0KG G/W:5.5KG MODEL: QTY:10000PCS LOT NO: </td> </tr> </table>				100pcs per plastic bag N/W:15g G/W:20g MODEL: QTY:50PCS LOT NO:	1000pcs per plastic box N/W:300g G/W:450g MODEL: QTY:1000PCS LOT NO:	10000pcs per out bag N/W:3.0KG G/W:5.5KG MODEL: QTY:10000PCS LOT NO:
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TITLE: packing		DRAWN: Lily	SCALE: 5/1			
PART NO.		DESIGNED: R & D OF D.S.	SHEET: 1 : 1			
DWG NO.		CHECKED: Emily	TOLERANCE ± 0.2			
REV		APPROVAL: Eric	UNLESS OTHERWISE SPECIFIED, ONE PLACE DECIMAL ± ***			
MATERIAL: *****		TWO PLACE DECIMAL ± *** THREE PLACE DECIMAL ± ****				
DS Changzhou Dragon State Electronic Co., Ltd						